

Slide-gate Dithering Effects on Transient Flow and Mold Level Fluctuations

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Outline

- Free surface modeling using moving grid technique with FVM approach (developed via UDF in FLUENT)
 - Model development and validation
 - Model application with previous dithering simulation
- Modeling transient fluid flow in CC SEN/mold region
 - Boundary conditions for CFD simulation in CC process
 - Flow rate prediction using gate-position-based model inlet
 - Free surface simulation during dithering top surface
 - Modification of mass and momentum equations shell
 - Pressure Modification domain outlet
 - Simulated flow pattern and free surface evolution
- Parametric study on mold level fluctuation during dithering using the flow rate model



Free Surface Modeling using a Moving Grid Technique

- Mold free surface must be modeled together with argon-steel multiphase flows to:
 - study the gravity wave effects during dithering;
 - difficulty rises in adopting both VOF and Eulerian-Eulerian models in the simulation using FLUENT;
 - a simple, accurate and computational efficient interface-tracking model must be developed to model free surface motion together with multiphase flow simulation during dithering.
- In current work, an interface tracking model is developed in FLUENT using the moving grid technique:
 - local mass conservation is enforced by moving the nodes properly following the Spatial Conservation Law (SCL);
 - both kinematic and dynamic boundary conditions are directly applied in the model to solve the momentum equations;
 - mesh smoothing is performed to ensure a good mesh quality.

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Moving Grid Technique using FVM

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 $\mathbf{r}_{\mathrm{B}_{i}}^{k+1}$

 $\mathbf{r}_{V_{i}}^{k+1}$

Continuity equation with moving mesh:

$$\nabla \cdot \left(\rho \left(\mathbf{v} - \mathbf{v}_g \right) \right) = 0$$

Momentum equation with moving mesh:

$$\frac{\partial (\rho \mathbf{v})}{\partial t} + \nabla \cdot \left(\rho \mathbf{v} \left(\mathbf{v} - \mathbf{v}_g \right) \right) = -\nabla p + \nabla \cdot \left(\mu \nabla \mathbf{v} \right) + \mathbf{F}$$

V is fluid velocity, while V_g is grid velocity (mesh velocity)

Kinematic B.C.:

$$\left[\left(\mathbf{v} - \mathbf{v}_{s} \right) \cdot \mathbf{n} \right]_{fs} = 0 \quad \text{or} \quad \dot{m}_{fs} = 0$$

Dynamic B.C.: all forces in equilibrium at fs.

This node moving approach has been adopted and coded into FLUENT UDF for free surface modeling in current work

Ref:



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$$\mathbf{v} + \mathbf{F} = \mathbf{r}_{B_i}^k + \Delta h \, \mathbf{e}_{fs} \qquad \Delta h = \gamma_{fs} \frac{\dot{V}_{fs}' \, \Delta t}{S_{fs} \, \mathbf{n} \cdot \mathbf{e}_{fs}} = \mathbf{r}_{V_i}^k - \mathbf{e}_{fs} \cdot \left| \mathbf{r}_{V_i}^k - \sum_{i=1}^n w_m \mathbf{r}_{B_m}^{k+1} \right| \mathbf{e}_{fs}$$

m = 1





Large Amplitude Sloshing



Example Problem:

Viscous liquid is filled in a long trapezoid-shaped container. The top wall of the container suddenly gets removed, and liquid is released to gravity

- Free surface nodes moved via UDF, with kinematic and dynamic B.C.s satisfied
- Side wall nodes and internal nodes are smoothed via solution of a Laplace equation diffusing free surface nodes displacements to interior nodes

Model Validation – Analytical Solution and Case Setup

• 2-D small-amplitude sloshing problem

$$a(t) = \frac{4\nu^2 k^4}{8\nu^2 k^4 + \omega_0^2} a_0 \operatorname{erfc}(\nu k^2 t)^{\frac{1}{2}} + \sum_{i=1}^4 \frac{Z_i}{Z_i} \left(\frac{\omega_0^2 a_0}{Z_i^2 - \nu k^2}\right) \exp\left(\left(Z_i^2 - \nu k^2\right) t\right) \operatorname{erfc}\left(Z_i t^{\frac{1}{2}}\right)$$

Where z_i is the *i*th root of the equation below, and z_i is defined as:

$$Z^{4} + 2\nu k^{2} Z^{2} + 4\left(\nu k^{2}\right)^{\frac{3}{2}} Z + \nu^{2} k^{4} + \omega_{0}^{2} = 0 \qquad \omega_{0} = \sqrt{gk}$$

Prosperetti, A., 1981. "Motion of two superposed viscous fluids". Physics of Fluids, 24(7), July, pp. 1217–1223.



Model Validation – Comparison with Analytical Solution



- Excellent match with analytical solution obtained even for simulations using the very coarse mesh
- Using second order (or higher) advection scheme and temporal scheme are crucial for achieving accuracy

Application to Simulate Dithering with Gas Injection

Casting parameters:

- Casting speed:
- Mold width:

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- Mold thickness:
- Submergence depth:
- Dithering amplitude:
- Dithering frequency:
- Total gas injection rate: 30 LPM (20 SLPM with 75% leakage based on 19psi back pressure [1])

40 ipm

72 inches

10 inches

8 inches

0.4 Hz

14 mm or 7 mm

- SEN bore diameter. 80 mm
- Plate diameter: 75 mm
- Cup bottom SEN bottom shape:

[1] (R. Liu and BG Thomas, AISTech 2012, (Atlanta, GA, May 7-9, 2012).



Free Surface Movement – **Pressure Method**





Free Surface Movement – Moving Grid



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Comparison of Simulated and Measured Mold Level

Pressure method:

 $\Delta h = \frac{p - p_0}{p - p_0}$

 $\rho_L g$

 p_0 is the static pressure at starting time (160 sec in current case) Pressure at quarter mold point at meniscus is used in current calculation



Results from both methods match reasonably well with measured mold level



Comparison of Free Surface Capturing Methods

- Pressure method
 - easiest to obtain, used only for post-processing
 - unable to model gravity waves
- Volume of Fluid (VOF)
 - fixed Eulerian mesh
 - smearing interface due to numerical diffusion from volume fraction equation
 - small time step required for stability restriction in explicit marching (expensive)
- Moving grid technique (in FVM)
 - moving mesh representing domain deformation (mixed Eulerian and Lagrangian mesh)
 - sharp interface directly obtained from mesh
 - cannot predict entrainment of the secondary phase



Conclusion – Part 1

- A free surface model with moving grid technique is developed in FLUENT via UDF based on its "dynamic mesh" feature.
- The free surface model has been validated using:
 - the small amplitude sloshing analytical solution, which proves that the model is accurate even with relative coarse mesh;
 - mold top surface motion during CC dithering process, which shows:
 - the capability of the model to simulate free surface behavior under gravity waves;
 - the model can be used together with Eulerian-Eulerian multiphase flow models to study free surface behavior in cases with argon injection into the CC mold



Modeling Transient Flows and Free Surface during the Dithering Trial

- List of Cases from ArcelorMittal Indiana Harbor 3SP dithering trial;
- Calculation of sloshing frequency
 - a rectangular tank (3-D solution);
 - an infinite deep channel (2-D solution).
- Computation of dithering effects on mold flow pattern and mold level fluctuations
 - computational model setup;
 - quasi-steady state flow pattern and free surface deformation;
 - flow and free surface evolution during dithering.



ArcelorMittal Indiana Harbor Dithering Trial

• Casting parameters for the dithering trial:

_	Casting speed:		40 ipm
_	Mold width:		72.5 inches
_	Mold thickness:		10 inches
_	Submergence de	epth:	5.6 inches
_	Total gas injection	on flow rate:	1 SLPM (1% in hot condition)
_	SEN bore diame	ter:	80 mm
_	Plate diameter:		75 mm
– SEN bottom shape:			Roof bottom
e #	Frequency (Hz)	Stroke (mm)	Mold Operator Comments

Case #	Frequency (Hz)	Stroke (mm)	Mold Operator Comments
1	0.6	14	Not many waves
2	0.8	14	More waves than 0.6 Hz
3	0.9	14	Giant sloshing, worst level scenario
4	1.0	14	More waves than 0.8 Hz
5	1.2	12	No waves in the mold, best frequency
6	1.4	7	Very few waves, but 1.2 Hz is better

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Numerical Simulation

- Domain geometry and mesh
- Computation condition:
 - Numerical parameters
 - Turbulence models
 - Discretization scheme
 - Boundary conditions
- Quasi-steady state solution
- Flow field evolution during dithering process simulating trial case 3



Computational Domain and Mesh





Flow Rate Calculation – Inlet B.C.

Equation for gate-position-based model (including gas effect):

$$Q_{SEN} = A_{eff} \sqrt{\frac{2g(H_1 + H_2)}{\left(\frac{A_{SEN}}{A_{port}} - 1\right)^2 + f\frac{L_{SEN}}{D_{SEN}} + \left(\frac{1}{\mu} - 1\right)^2 \left(\frac{A_{SEN}}{A_{GAP}}\right)^2 + \left(\frac{A_{SG}}{A_{GAP}} - \frac{A_{GAP}}{A_{SG}}\right)^2 \left(\frac{A_{SEN}}{A_{SG}}\right)^2 + \left(\frac{A_{SEN}}{2A_{port}}\right)^2}$$
where
$$\mu = 0.63 + 0.37 \left(\frac{A_{GAP}}{A_{SG}}\right)^3 \qquad A_{eff} = \begin{cases} A_{SEN} & \text{single phase flow} \\ \frac{V_c WT}{Q_{gas} + V_c WT} A_{SEN} & \text{two phase flow} \end{cases}$$

For continuous caster, an extra term should be added to account for pressure drop due to clogging:

$$Q_{SEN} = A_{eff} \sqrt{\left(\frac{A_{SEN}}{A_{port}} - 1\right)^2 + f \frac{L_{SEN}}{D_{SEN}} + \left(\frac{1}{\mu} - 1\right)^2 \left(\frac{A_{SEN}}{A_{GAP}}\right)^2 + \left(\frac{A_{SG}}{A_{GAP}} - \frac{A_{GAP}}{A_{SG}}\right)^2 \left(\frac{A_{SEN}}{A_{SG}}\right)^2 + \left(\frac{A_{SEN}}{2A_{port}}\right)^2 + C}$$

In current study, *C*=*0* is assumed (no clogging).

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Flow Rate Curve – Inlet B.C. (Gate Position vs. Flow Rate)

curves for 75 mm Slide Gate Plate Bore Diameter

Nice match obtained, analytical SEN flow rate model is validated Gap area is:

225

200



$$A_{GAP} = \frac{D_1^2}{4} \arcsin\left(\frac{2h}{D_1}\right) + \frac{D_2^2}{4} \arcsin\left(\frac{2h}{D_2}\right) - Dh,$$



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Pressure Boundary Modification – Domain Outlet B.C.

 Q_T : target flow rate Q_C : calculated flow rate p_T : target pressure p_C : calculated (prescribed) pressure at domain outlet

- The proper B.C. at domain outlet should be a specific (target) flow rate, calculated from:
 - Slab dimension
 - Casting speed
- Pressure has to be modified to enforce the target flow rate at each time step, using Bernoulli's equation:

$$p_{c} + \frac{\rho V_{c}^{2}}{2} = p_{T} + \frac{\rho V_{T}^{2}}{2} \implies dp = p_{T} - p_{c} = \rho \frac{V_{T}^{2} - V_{c}^{2}}{2}$$

The average pressure correction at domain outlet is:

$$d\overline{p} = \rho \frac{\left(\frac{Q_{T}}{WT}\right)^{2} - \left(\frac{Q_{c}}{WT}\right)^{2}}{2}$$

 This average pressure
 correction should be added to the pressure B.C. at domain outlet every iteration

Simulation Results – **Quasi-Steady State Solution**

k-ω Model vs. DES Model

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1.40 0.5 0.5 1.24 1.09 0.6 0.6 0.93 0.78 Mold Length (m) 0.63 0.7 0.7 0.47 0.32 0.8 0.8 0.16 0.01 0.9 0.9 1 1.1 1.1 1.2 1.2 0.5 0.6 0.1 0.2 0.3 0.4 0.7 0.8 0.9 0.2 0.5 0.6 0.7 0.8 0.1 0.3 0.4 0.9 Mold Width (m) Mold Width (m)

-- velocity distribution from $k-\omega$ model (diffusive turbulence model used to obtain ensemble averaged solution)

-- velocity distribution from DES model (DES switching between k- ω model and LES)

Liquid Steel Velocity (m/s)



DES Simulated Transient Flow Pattern (quasi-steady state)

Center plane velocity distribution





Free Surface Motion (quasi-steady state)





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Calculation of Sloshing Frequency in a Rectangular Tank

 M.C. Kim and S.S. Lee^[1] suggested the following equation to calculate the sloshing frequency in a rectangular tank

$$f_{i,j}^{2} = \frac{g}{4\pi} \sqrt{\left(\frac{i}{a}\right)^{2} + \left(\frac{j}{b}\right)^{2}} \tanh \left[\pi h \sqrt{\left(\frac{i}{a}\right)^{2} + \left(\frac{j}{b}\right)^{2}}\right]$$

In the dithering case, half mold width a is 36.25 inch (0.92 m), and mold thickness b is 10 inch (0.254 m), supposing only mode (i,j) = (1,0) occurs due to SEN blocking effect.



$$f_{1,0} = \sqrt{\frac{g}{4\pi a}} = \sqrt{\frac{9.8067}{4\pi \times 0.92}} = 0.92Hz$$

 A. Prosperetti^[2] derived the analytical solution for 2-D small amplitude waves (sloshing) problem, with the natural frequency as a function of gravity acceleration and wave number k:

$$\omega_{0} = \sqrt{gk} \qquad k = \frac{n\pi}{a} \quad \text{for n = 1, frequency is:} \qquad f = \frac{\omega_{0}}{2\pi} = \sqrt{\frac{g}{4\pi a}} = 0.92Hz$$
Ref:
[1] M.C. Kim and S.S. Lee, "HYDROELASTIC ANALYSIS OF A RECTANGULAR TANK".
[2] A. Prosperetti 1981 "Motion of two superposed viscous fluids". Physics of Eluids. 24(7). July pp. 1217–1223

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Flow Rate Variation during Dithering in Case 3 (Giant Sloshing)

 Measured slide-gate position is converted into inlet flow rate variations using the gate-positionbased model





Case 3: Flow Pattern Evolution at Mold Center Plane





Case 3: Free Surface Behavior



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Center Plane Velocity Evolution Continuous Casting Consor for Case 3 Consortium





Free Surface Sloshing for Case 3





Conclusion – Part 2

- Computational models were setup and successfully adopted to investigate transient flow and free surface evolution, with:
 - Predicted flow rate at nozzle inlet B.C.
 - Mass/momentum sink terms at shell
 - Modified pressure B.C. at domain outlet
- Sloshing frequency is calculated via analytical solutions and validated via numerical simulation;
- The "swing" effect is identified via simulated results as the cause of giant sloshing which was observed to occur when dithering frequency matches with sloshing frequency.



Parametric Study on Mold Level Fluctuations during Dithering

- Simpler models are needed to predict average mold level fluctuations during dithering process:
 - derived from global mass conservation
 - with flow rate calculated from gate-position-based model
- Effects of the following factors are investigated via parametric study using the simple average mold level model, including:
 - dithering stroke
 - casting speed





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Continuous Casting Consor **Case 2 – 0.8 Hz, 14 mm stroke** Consortium Gate position (mm) Mold level (mm) f = 0.8 Hz Case 2 stroke = 14 mm Mold level deviation (mm) -3 -2 -1 Time (sec) Metals Processing Simulation Lab University of Illinois at Urbana-Champaign Rui Liu •



Case 3 – 0.9 Hz, 14 mm stroke











Case 6 – 1.4 Hz, 7 mm stroke





Mold Level Fluctuation

Mold level fluctuation (rms) defined as:

$$h' = h - \overline{h}$$
 $\sqrt{\overline{h'^2}} = \sqrt{\frac{\sum\limits_{i=1}^{N} \left(h - \overline{h}\right)^2}{N}}$



Flow rate variation (rms) defined as:

$$d' = d - \overline{d} \qquad \sqrt{\overline{d'^2}} = \sqrt{\frac{\sum\limits_{i=1}^{N} \left(d - \overline{d}\right)^2}{N}}$$

- Monotonic correlation found between flow rate variation and mold level fluctuations
- Mold level fluctuation deviates from the correlation when dithering frequency is very close to sloshing frequency of the mold (0.92 Hz in current case)



Casting Speed Effect on Level Fluctuations

Tundish level: 58 inches

Mold width: 72.5 inches

Dither frequency: 0.8 Hz



- Higher speed causes more gate opening, operating in steeper part of flow rate/gate position curve, thus increasing flow-rate and level variations
- For each casting speed, both flow rate variation and mold level fluctuation change almost linearly with dithering stroke (not at sloshing frequency)



Backlash Effect on Slide Gate Position

Connecting d = 1 mm Initial position of the Slide Gate Cylinder Block cylinder relative to the connecting block is crucial to backlash analysis, L **≐** 2 mm d and L are the two d = 0.mmimportant parameters Schematic of backlash from **ArcelorMittal Research Center at** L = 2 mm **East Chicago** Effect of Backlash on Slide Gate Position ---without Backlash, L = 0 mm with Backlash, d = 0 mm 5 with Backlash, d = 1 mm with Backlash, d = 2 mm Slide Gate Position (mm) -4 -5 -6 -7 0 0.5 1.5 2 2.5 1 Time (sec) 43 Metals Processing Simulation Lab Rui Liu University of Illinois at Urbana-Champaign



- Dithering frequency does not affect mold level fluctuations unless it is very close to the sloshing frequency of the mold (less than ±0.1 Hz);
- Predicted mold level fluctuation matches reasonably well with measurements, which proves the potential use of the simple analytical model during dithering;
- Flow rate variation during dithering is approximately linearly correlated with dithering stroke;
- Increasing casting speed or tundish level increases mold level fluctuation by opening the slide-gate wider, which creates more flow rate variation during dithering.



- Effects of backlash on mold level fluctuation is complicated:
 - both "actual" slide-gate position and dithering stroke are affected by backlash;
 - Initial position of slide-gate, together with the initial relative position of connecting block and cylinder determines the actual flow rate and flow rate variation during dithering;
 - Slide-gate dithering from a steady gate position for a casting speed will cause mold level to rise, thus the average position of the slide-gate dithering should be calibrated taking into account both local slope of flow rate curve and backlash effect.



- Multiphase flow modeling
 - CU-FLOW GPU code development with Eulerian-Lagrangian approach to model two phase bubbly flows in CC process;
 - model validation using water model PIV experiment
- More parametric study cases with:
 - the effect of mold width on flow rate variation and mold level fluctuation
 - backlash effect on flow rate during dithering



- Continuous Casting Consortium Members (ABB, ArcelorMittal, Baosteel, Tata Steel, Magnesita Refractories, Nucor Steel, Nippon Steel, Postech, Posco, SSAB, ANSYS-Fluent)
- Hongbin Yin, Tathagata Bhattacharya, Love Kalra, Kai Zheng, William Umlauf and Aloka Dasgupta in ArcelorMittal East Chicago research center
- Jean-Francois Domgin in ArcelorMittal Maizières France and Joydeep Sengupta in ArcelorMittal Dofasco in Canada
- Students in Metals Processing Simualtion Lab in UIUC